Electrical Properties of Teflon and Ceramic Capacitors at High Temperatures

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ABSTRACT

Space power systems and components are often required to operate efficiently and reliably in harsh environments where stresses, such as high temperature, are encountered. These systems must, therefore, withstand exposure to high temperature while still providing good electrical and other functional properties. In this work, experiments were carried out to evaluate teflon and ceramic capacitors for potential use in high temperature applications. The capacitors were characterized in terms of their capacitance and dielectric loss as a function of temperature, up to 200 °C. At a given temperature, these properties were obtained in a frequency range of 50 Hz to 100 kHz. DC leakage current measurements were also performed in a temperature range from 25 to 200 °C. The results obtained are discussed and conclusions are made concerning the suitability of the capacitors investigated for high temperature applications.

INTRODUCTION

Electrical components and systems are often required to operate reliably in harsh environments where stresses of different kinds and intensities are encountered. High temperature constitutes one of these stresses which exists in space-based as well as terrestrial environments. Space exploration missions (lunar base), nuclear-powered space vehicles, integrated engine electronics, satellite power conditioning, and SDI systems are examples of advanced space electric power systems which will require electrical components capable of long-term operation at high temperatures. Terrestrial applications where high temperature is present include well logging, geothermal energy extraction, nuclear power plants, and automotive and locomotive engine electronics.

High temperatures can also be developed internally due to the fact that most power processing and conditioning devices generate heat during their normal mode of operation. The generation of heat and its build-up are believed to greatly influence the performance of these devices as they cause gradual degradation which eventually leads to catastrophic failure. This internally developed thermal stress is becoming more severe as the currently emerging demand for aerospace technology places a great emphasis on increasing the energy densities and raising the power levels of space-based power systems and components. For instance, future plans for many space exploration missions call for tremendous increases in the power capability to a magnitude on the order of megawatts [1]. These requirements will certainly result in raising the operating temperature of the devices concerned [2].

The development of high temperature power components and devices is therefore necessary to meet the challenges of advanced space power technology with objectives to reduce size and weight, increase packaging density, improve performance, and increase lifetime. Among the various benefits that can be gained from the availability of high temperature electronics include reduced launch cost, simplified thermal management systems, and improved device survivability. For example, it has been reported that high temperature components can make significant improvement in reliability for satellite missions on the order of a hundred years [3].

Teflon and ceramic power capacitors were evaluated for potential use in high temperature applications. The capacitors were characterized in terms of their capacitance and dielectric loss as a function of temperature, up to 200 °C, in a frequency range of 50 Hz to 100 kHz. The effect of temperature on the DC leakage current was also determined. In this paper, the experimental procedures and the results obtained are discussed.

EXPERIMENTAL PROCEDURES

In an earlier work, the authors investigated off-the-shelf high temperature capacitors that employed glass, teflon, or solid tantalum as the dielectric [4]. These capacitors were signal-level devices, and some required derating with temperature. It was found that amongst the three capacitors tested, the teflon capacitor had shown superiority in terms of thermal stability. An effort was then made to develop and characterize power-level capacitors suitable for operation in high temperature environments. In this work, power capacitors made of metallized-teflon (Component Research Co.) and COG/NPO ceramic (Olean Advanced Products) were evaluated at high temperatures. Table I lists some of the design requirements and the manufacturer's specifications [5,6].

Capacitance and dissipation factor of the capacitors were obtained as a function of temperature, up to 200 °C, using a Hotpack benchtop oven. At a given temperature, these properties were obtained in a frequency range of 50 Hz to 100 kHz using a GenRad Model 1689 Digibridge. DC
leakage current measurements were also performed in a
temperature range from 25 to 200 °C using a Keithley
Model 237 Source-Measure Unit. In performing the leakage
current measurements, the capacitor under test was
allowed to charge by supplying the proper voltage through a
10 kΩ current-limiting resistor. DC voltages of 200 V and
500 V were applied for the teflon and the ceramic capaci-
tor, respectively. The leakage current was recorded 5
minutes after voltage application. Such a time was required
for the current to reach stability. Each capacitor was then
discharged completely before the next measurement was
made.

RESULTS AND DISCUSSIONS

The change in capacitance of the teflon capacitor with
temperature is shown in Figure 1. It can be clearly seen
that the capacitor undergoes gradual but slight reduction in
its capacitance with increasing temperature. This decrease,
which becomes noticeable when the temperature exceeds
125 °C, is very minimal as it amounts, even at the highest
temperature of 200 °C, to only about 2 % of its original
value. In addition to being relatively stable with tempera-
ture, the teflon capacitor displayed no capacitance change
with frequency. It should be noted that the results shown
in Figure 1 not only represent those taken at the lowest (50
Hz) and the highest (100 kHz) frequency, but rather the
data for the full frequency range between 50 Hz and 100
kHz.

Similarly, the frequency was found to have little effect on
the change of capacitance of the ceramic capacitor as
depicted in Figure 2. In terms of temperature, the ceramic
capacitor displayed excellent thermal stability as its capaci-
tance remained relatively constant from 25 to 200 °C. This
is expected as ceramics, especially the COG type, are
known to exhibit good stability with temperature.

The dissipation factor of the teflon capacitor as a function
of temperature and at different frequencies is shown in
Figure 3. It is evident that the dissipation factor, at a given
frequency, exhibits a slight increase with increasing tempera-
ture. The increase in the loss, which occurs mainly in the
high temperature regime, can be attributed to increasing the
ionic conduction caused by some ionic mechanism which is
thermally activated [7]. At a given temperature, the
dissipation factor seems to increase dramatically with an
increase in frequency. Although most polymeric dielectrics
are known to undergo an increase in their loss factor with
frequency due to dipole orientation, space charge accumula-
tion, electronic polarization, and molecular relaxation, the
increase is typically modest in nature and occurs at very
high frequencies. Therefore, the dramatic increase in the
dissipation factor with frequency as presented in Figure 3
cannot be attributed to the polymer film but rather to the
resistance of the terminations and leads of the capacitors.
Proper design techniques and improved manufacturing
processes will certainly minimize, if not eliminate, these
losses.

The ceramic capacitor shows similar trend in its dissipation
factor with temperature as that of the teflon capacitor only
at high frequencies, as shown in Figure 4. That is, a steady
but very slight increase in the dissipation factor is associat-
ed with increase in temperature at frequencies at and above
20 kHz. At the low frequencies, namely 50 Hz and 1 kHz,
this property, however, exhibits significant increase with
temperature. This effect is more profound at 50 Hz and
when the temperature exceeds 100 °C. The change in the
dielectric loss behavior of the ceramic capacitor with
frequency and temperature can be attributed to many
factors and mechanisms such as the presence of ionic
impurities, grain boundary effects, interfacial polarization,
and charge transport phenomena.

Figure 5 depicts the DC leakage current of the capacitors as
a function of temperature. It can be seen that the leakage
currents for both capacitors increase with temperature but
with different intensities. That is, while the teflon capacitor
starts to exhibit a moderate increase in leakage current at
temperatures beyond 150 °C, its ceramic counterpart under-
goes a marked increase as the temperature exceeds 100 °C.
For example, the increase in the leakage current of the
ceramic capacitor amounted to about three orders of
magnitude when temperature of 200 °C is reached. As
pointed out earlier, interfacial polarization losses as well as
conduction losses by charge carriers in the ceramic dielec-
tric might have been responsible for the increase in the
leakage current with temperature. The application of higher
bias voltage may have been also a factor as 200 V and 500
V were applied in these tests to the teflon and ceramic
capacitors, respectively.

CONCLUSION

The results of this work indicate that both the teflon and
ceramic capacitors display temperature-dependence in their
dielectric properties. The frequency was also found to have
an effect on these properties; in particular, the dissipation
factor. Further experimental studies, such as thermal aging

TABLE I. CAPACITORS SPECIFICATIONS [5,6]

<table>
<thead>
<tr>
<th>Property</th>
<th>Teflon</th>
<th>Ceramic</th>
</tr>
</thead>
<tbody>
<tr>
<td>Capacitance (µF)</td>
<td>1.0</td>
<td>1.0</td>
</tr>
<tr>
<td>Capacitance Tolerance (%)</td>
<td>5</td>
<td>±10</td>
</tr>
<tr>
<td>Voltage (VDC)</td>
<td>200</td>
<td>500</td>
</tr>
<tr>
<td>Operating Temperature (°C)</td>
<td>-65 to +200</td>
<td>-55 to +200</td>
</tr>
<tr>
<td>Dissipation Factor (%)</td>
<td>0.05 Max @ 25 °C</td>
<td>0.15 Max @ 25 °C</td>
</tr>
</tbody>
</table>
and testing at full rated power, are required to better and fully characterize these and other capacitors for potential use in high temperature environments.

ACKNOWLEDGMENTS

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REFERENCES


[5] Component Research Company, High Reliability Film Capacitors, Catalog W.


Figure 1. Change in capacitance of teflon capacitor with temperature.

Figure 2. Change in capacitance of ceramic capacitor with temperature.
Figure 3. Dissipation factor of teflon capacitor as a function of temperature.

Figure 4. Dissipation factor of ceramic capacitor as a function of temperature.

Figure 5. Comparison of leakage currents with temperature.
**Title and Subtitle**

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**Subject Terms**

Capacitors; High temperature; Power components